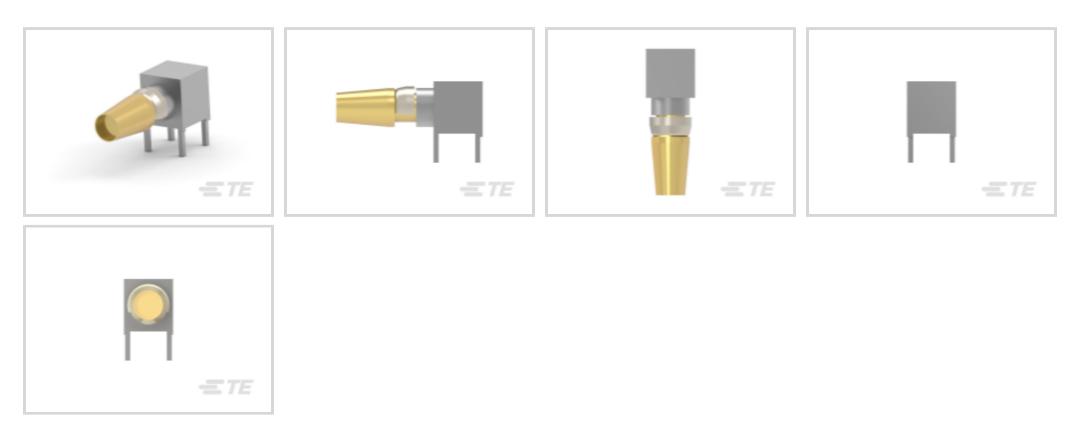


# Z-PACK | Z-PACK 2mm HM

TE Internal #: 148513-1 TE Internal Description: TYPE M RECPT CONT R/A PCB MNT View on TE.com >



Connectors > PCB Connectors > Board-to-Board Connectors > Board-to-Board Connector Contacts



Contact Type: Socket

Contact Mating Area Plating Material: Gold

Contact Orientation: Right Angle

Connector & Contact Terminates To: Printed Circuit Board

Circuit Application: Power

# Features

# **Product Type Features**

Connector & Contact Terminates To	Printed Circuit Board
Contact Features	
PCB Contact Termination Area Plating Material Thickness	2.54 μm[100 μin]
Contact Mating Area Plating Material Thickness	1.27 μm[50 μin]
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Base Material	Brass
Contact Type	Socket
Contact Mating Area Plating Material	Gold
Contact Orientation	Right Angle
Termination Features	
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Wire Insulation Support	Without
PCB Mount Retention	Without



Usage Conditions	
Operating Temperature Range	-55 – 125 °C[-67 – 257 °F]
Operation/Application	
Circuit Application	Power
Packaging Features	
Packaging Quantity	25
Packaging Method	Carton
<b>Product Compliance</b> For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Not Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUN 2020 (209) SVHC > Threshold: Pb (3.7% in Component part) Pb (13% in Component part)

### Halogen Content

### Solder Process Capability

# Pb (13% in Component part)

#### Pb (.6% in Component part)

#### Article Safe Usage Statements:

Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.

Not Yet Reviewed for halogen content

Hand solderable with tin/lead solder

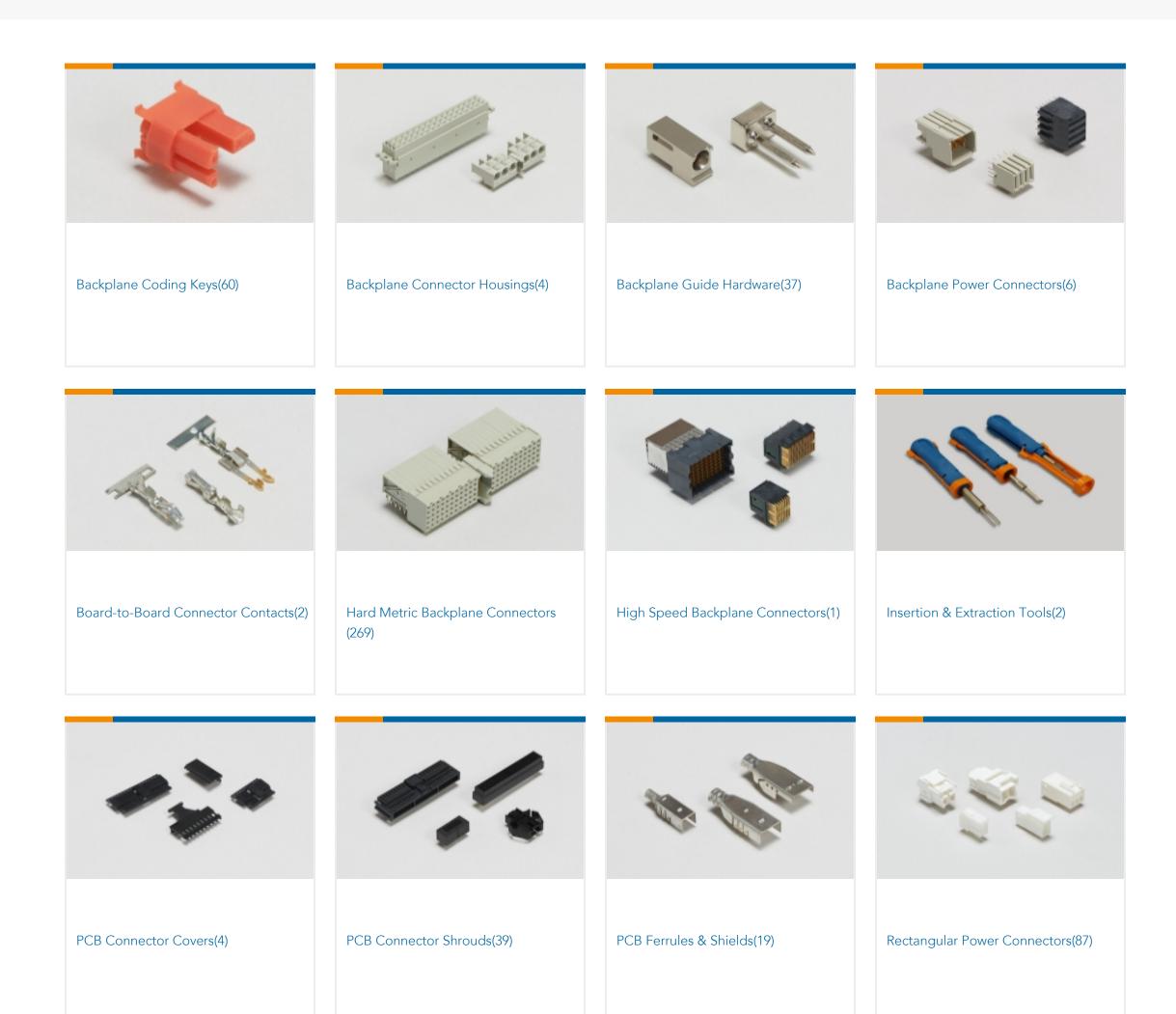
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

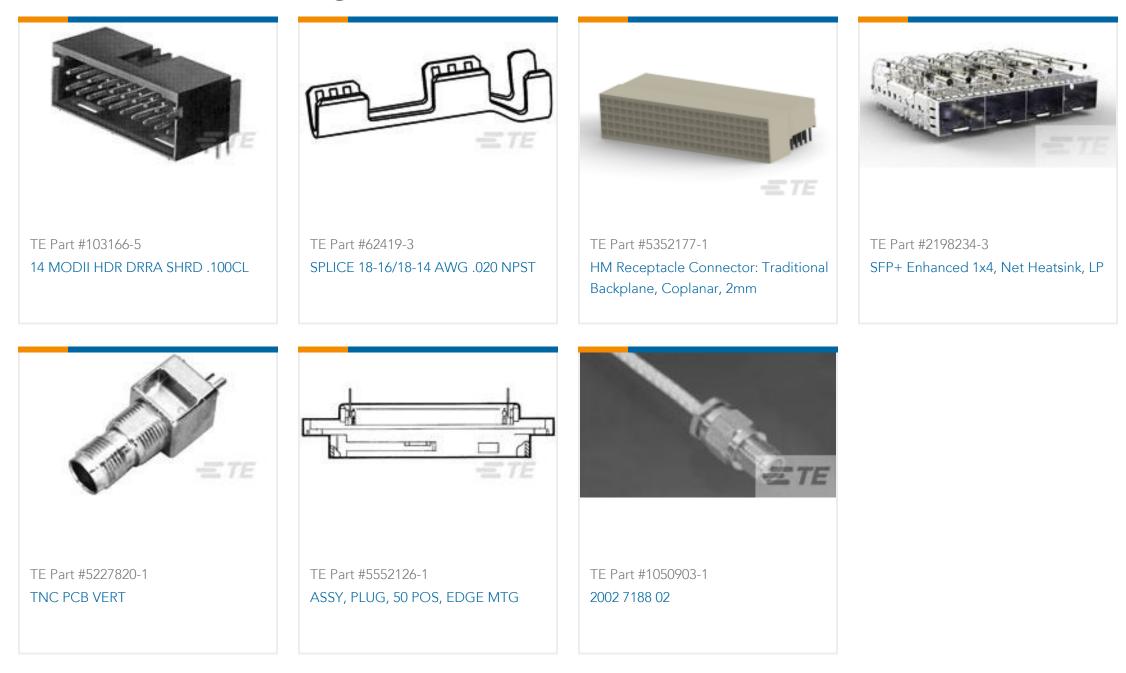
# Also in the Series Z-PACK 2mm HM

#### TYPE M RECPT CONT R/A PCB MNT





# Customers Also Bought



# Documents

**C** For support call+1 800 522 6752

148513-1

TYPE M RECPT CONT R/A PCB MNT



Product Drawings TYPE M RECPT CONT R/A PCB MNT

English

**CAD** Files

3D PDF

3D

Customer View Model

ENG\_CVM\_CVM\_148513-1\_D.2d\_dxf.zip

English

Customer View Model

ENG\_CVM\_CVM\_148513-1\_D.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_148513-1\_D.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications Application Specification

English